Abstract

Gallium nitride films grown on sapphire substrate were investigated using Scanning Microwave Microscopy (SMM). During the growth thin, highly doped layers were included to mark the shape of the surface at regular intervals. The SMM’s capability to measure dopant densities was employed to reconstruct cross sections of these surfaces. An unintentionally doped region was found for the initial stages of the growth. The growth surface at this stage is rough with most parts of the surface tilted out of the substrate plane. This suggests a model in which inclined surfaces promote the unintentional uptake of dopant material. Later stages of the growth result in smooth surfaces without unintentional doping.
Introduction

GaN is a III – V semiconductor with a wide band gap. It is used in optoelectronics especially for the production of blue and green light emitting diodes (LED), high power, high temperature, and high frequency devices. It can also be doped with magnetic impurities which has possible applications in spintronics. A main challenge for the production of GaN based devices is the lack of suitable substrate materials. It remains very difficult to grow large GaN single crystals so that devices are mainly fabricated on sapphire and SiC substrate wafers. The heteroepitaxial growth of GaN layers on sapphire substrate can be compromised by unintentional doping during the growth process. Identification of the origin and the mechanism of incorporation of dopants is needed to optimize the GaN based heterostructures for electronic devices.

Investigation of Gallium Nitride Growth

For the investigation of unintentional doping of GaN an overgrowth technique was employed. Nominally undoped material was grown. At regular intervals dopant material was introduced into the growing GaN for short periods thus forming thin layers of highly doped GaN. The sample was then cleaved to expose a cross section of the grown film and the marker layers. Figure 1 shows SMM topography, capacitance map, dopant density map of the film cross section, and a line profile across the dopant density map.

Scanning Microwave Microscopy can be used to measure the density of charge carriers in semiconductors at a high spatial resolution. SMM combines the very high capacitance sensitivity of a Vector Network Analyzer (as the Keysight Technologie Inc. PNA) with the high spatial resolution of a beam deflection Atomic Force Microscope (AFM). Working on semiconductors the capacitance of the tip sample junction is influenced by the applied tip sample bias. This is well known behavior in semiconductors and especially in Metal-Insulator-Semiconductor junctions (MIS). Many semiconductors like Silicon or GaAs form an insulating oxide layer when exposed to oxygen or air. This so called native oxide generally is very thin on the order of Angstroms but thickness can be increased by thermal treatment with several hundred degrees. A metallic SMM tip scanning a semiconductor surface in ambient conditions forms a MIS junction. When applying a bias voltage Vt to the SMM tip charge carriers in the semiconductor are attracted or depleted at the surface. A space charge region is formed. For a given semiconductor the thickness of the space charge region varies with Vt which affects the capacitance of the MIS junction. The width of the space charge region is also a function of the charge carrier density in the semiconductor which in many cases is equal to the concentration of impurity donor or acceptor atoms i.e. the dopant density.
surface. In SMM dopant density maps undoped as well as highly doped material yield lower signal or darker regions. The dark regions comprise the sapphire substrate, the highly doped marker layers, and the undoped GaN layers. The regions are indicated in figure 1d. The bright features are regions with a low but not too low density of charge carriers. This is the case in the regular stripes towards the wafer surface. Between the layers dubbed “undoped” a layer of highly doped material was grown. Both materials have little dC/dV signal and show dark. Due to diffusion of carriers from the doped into the undoped layers a low density of carriers is present at the edge of the undoped region and thus shows a high dC/dV signal. The straight regular stripes indicate that the film growth of these layers was regular and smooth.

In between the substrate and the smooth layers we find another region of doped material. This region was unintentionally doped during the growth process. In this region we find one to three dark bands meandering from left to right. The bands are highly doped marker layers. They mark the position of the growth surface at those times when dopant material was introduced. In the unintentionally doped region the doped layers show a strong fluctuation indicating a rough surface during growth.

The model assumption that inclined surfaces are crucial for the growth of unintentionally doped material can be tested with dopant density maps of larger regions. Figure 2 shows topography and dopant density map of a 64µm wide scan. Additionally a schematic shows the positions of the substrate, three marker layers, the unintentionally doped region and it’s boundary as yellow, red, lines, black hashed areas, and blue lines respectively. Due to the cleavage steps and contaminations the marker layers and the doped region cannot be traced across the whole cross section so that some gaps remain in the lines.

The assumption that inclined surfaces are crucial for the growth of unintentionally doped material is supported by the fact that this material is present mainly in the regions where the marker layers fluctuate. Locations marked “A” and “B” are of
References


Conclusion

Scanning Microwave microscopy was employed to investigate the origin of unintentionally doped regions in Gallium Nitride grown on sapphire substrate. During the growth process thin marker layers were introduced which are snapshots of the surface configuration. Cross sections through these surfaces reveal that unintentionally doped regions grow at initial stages of the growth when the surface is rough and most parts of the surface are tilted out of the substrate plane.

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